

View Online at <https://aerobasegroup.com/nsn/5910-01-381-9270>

Body Style:

Chip type

Reliability Indicator:

Established

Reliability Failure Rate Level In Percent:

0.001

Terminal Length:

Between 0.3 millimeters and 0.7 millimeters

Body Length:

Between 3.0 millimeters and 3.4 millimeters

Body Width:

Between 1.4 millimeters and 1.8 millimeters

Body Height:

1.3 millimeters

Schematic Diagram Designator:

No common or grounded electrode (s)

Insulation Resistance At Maximum Operating Temp:

1000.0 megohms

Capacitance Value Per Section:

10000.000 picofarads single section

Voltage Temperature Limits Per Section In Percent Capacitance Change:

-25.0/+15.0 with rated voltage applied single section

Nonderated Operating Temp:

Between -55.0 degrees celsius and 125.0 degrees celsius

Nonderated Continuous Voltage Rating And Type Per Section:

100.0 dc single section

Tolerance Range Per Section:

-10.00/+10.00 percent single section

Case Material:

Ceramic

Insulation Resistance At Reference Temp:

100000.0 megohms

Dissipation Factor At Reference Temperature In Percent:

2.500

Terminal Surface Treatment:

Solder

Test Data Document:

81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

Terminal Type And Quantity:

2 bonding pad

Specification Data:

81349-mil-c-55681/8 government specification

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

A010b0